

Features

- Defrost mode for frozen bread
- Reheat mode
- Operating voltage: 3.5~5.5V
- Few external components
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/contact-us) or your local Diodes representative.
- <https://www.diodes.com/quality/product-definitions/>
- Packaging (Pb-free & Green):
 - 8-DIP (P)

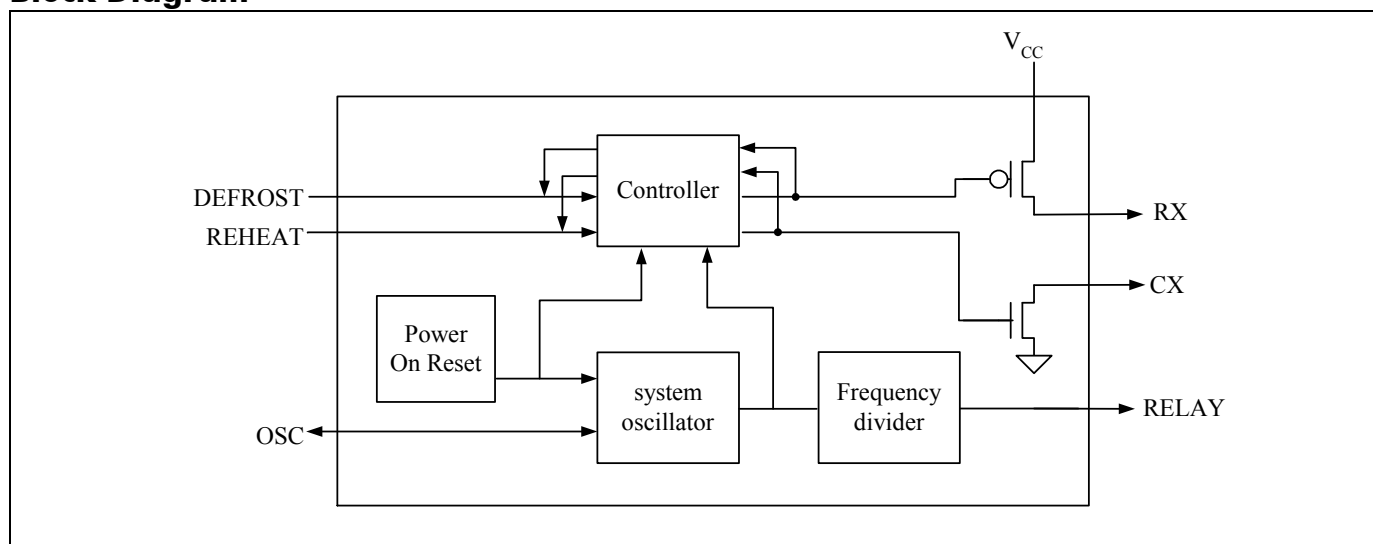
Description

The PT8A2511 is a CMOS LSI chip designed for toaster. Besides normal heating, it also provides defrost and reheat work modes. It provides low cost solution for toaster.

Applications

- Toaster

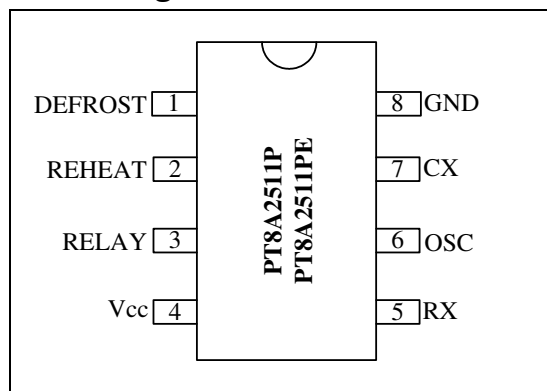
Block Diagram



Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Configuration



(Top View)

Pin Description

Name	Pin No.	Type	Description
DEFROST	1	I/O	As input, requires a negative pulse to active "Defrost" function. As output, gives a "Defrost" function indicator
REHEAT	2	I/O	As input, requires a negative pulse to active "Reheat" function. As output, gives a "Reheat" function indicator
RELAY	3	O	RELAY drive output. High active.
Vcc	4	-	Power supply
RX	5	O	Shorts to VCC once an active negative pulse appears at Reheat
OSC	6	I/O	Oscillator input/output, oscillator's Frequency of 1024Hz with an external R1,C1
CX	7	O	Shorts to GND once an active negative pulse appears at Defrost
GND	8	-	Power Ground

Maximum Ratings

Storage Temperature	-40°C to +125°C
Supply Voltage to Ground Potential (Inputs & VCC Only).....	-0.5 to +6.5V
Supply Voltage to Ground Potential (Outputs & D/O Only)	-0.5 to +6.5V
DC Input Voltage.....	-0.5 to +6.5V
DC Output Current	20mA
Power Dissipation	500mW
Junction Temperature	125°C max

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

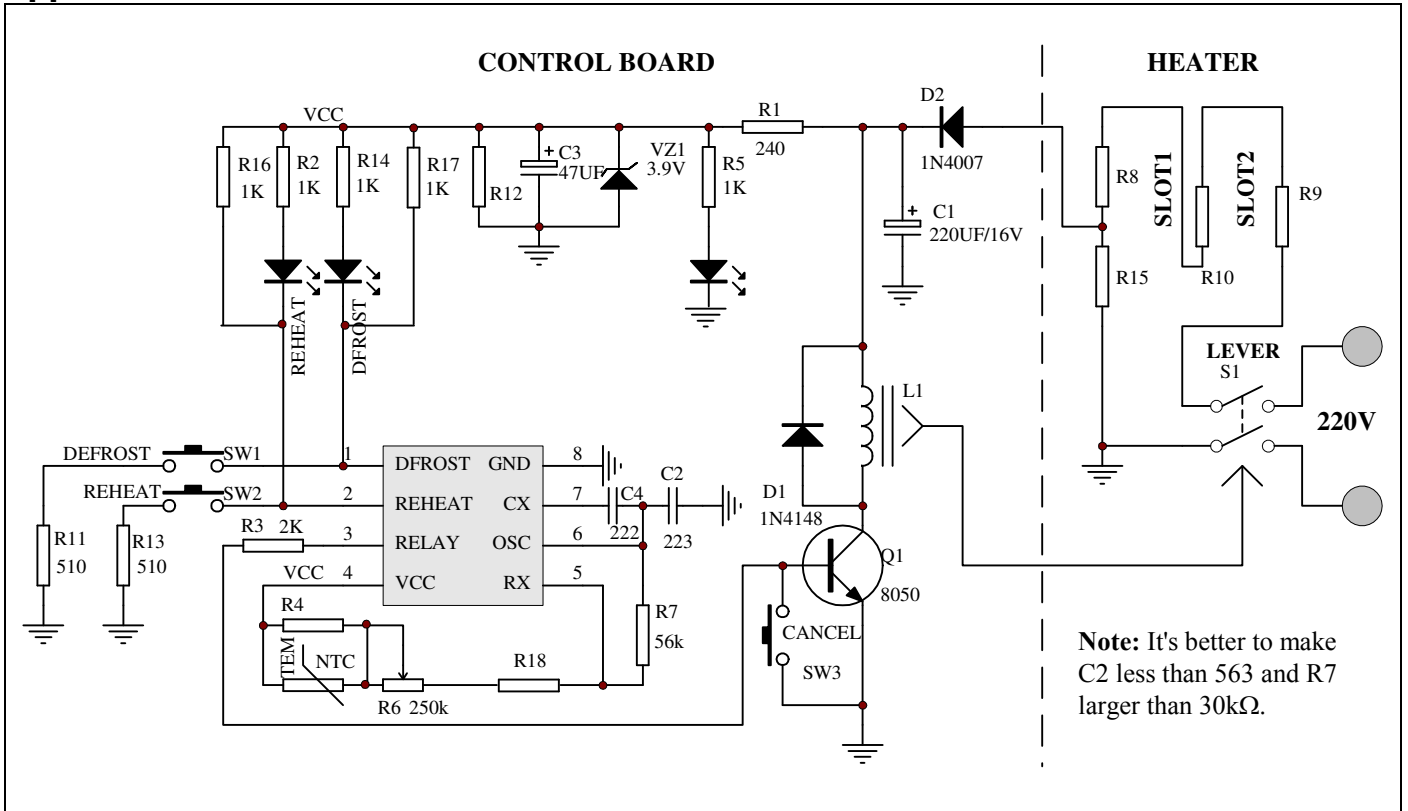
Recommended Operation Conditions

Symbol	Description	Min	Type	Max	Unit
T _A	Operation Temperature	0	25	+85	°C
V _{CC}	Supply voltage	3.5	4.0	5.5	V
V _{IH}	Input High Voltage	0.8V _{CC}	-	0	V
V _{IL}	Input Low Voltage	0	-	0.35V _{CC}	V

Electrical Characteristics (T_A = 0 ~ 85°C, unless otherwise noted)

Symbol	Description	Test Conditions	Min	Type	Max	Unit
V _{IL}	Input High Voltage	PIN: DEFROST, REHEAT V _{CC} =4.0V	-	-	2.0	V
I _{OH}	Output Source Current	PIN: DEFROST, REHEAT V _{CC} =3.5V V _{OH} =3.0V	-2.0	-	-	mA
I _{OL}	Output Sink Current	PIN: DEFROST, REHEAT V _{CC} =3.5V V _{OL} =0.5V	4	-	-	mA
I _{OH}	Output Source Current	PIN: RELAY V _{CC} =3.5V V _{OH} =2.0V	-15	-	-	mA
I _{OL}	Output Sink Current	PIN: RELAY V _{CC} =3.5V V _{OL} =0.5V	0.5	-	-	mA
I _{IH}	Input High Leakage Current	- V _{CC} =4.0V V _{IH} =3.5V	-	-	-1	μA
I _{IL}	Input Low Leakage Current	- V _{CC} =4.0V V _{IL} =0.5V	-	-	1	μA
OSC	Frequency of normal oscillator	V _{CC} =4.0V, R1=56kΩ, C1=223	952	1024	1096	Hz
I _{CC}	Power supply Current	V _{CC} =4.0V, R1=56kΩ, C1=223, all output floating	-	-	100	μA

Application Circuit



Part Marking

PT8A
 2511PE
 XYYWWJW

XYYWW: Die Rev/Year and Workweek of mold operation
 J: Assembly Site Code
 W: Wafer Fab Site Code

Packaging Mechanical
8-DIP- (P)

PKG. DIMENSIONS(MM)		
SYMBOL	Min	Max
A	3.71	4.31
A1	0.51	
A2	3.20	3.60
B	0.38	0.57
B1	1.52 BSC	
c	0.20	0.36
D	9.00	9.40
E	6.20	6.60
E1	7.32	7.92
e	2.54 BSC	
L	3.00	3.60
E2	8.40	9.00

Notes:
1. Refer JEDEC MS-001D/BA

PERICOM Enabling Serial Connectivity		DATE: 06/14/13
DESCRIPTION: 8-Pin, Dual InLine Plastic, DIP		
PACKAGE CODE: P (P8)		
DOCUMENT CONTROL#: PD-2134	REVISION: --	

13-0173

For latest package info.

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

Ordering Information

Part Number	Package Code	Package Description
PT8A2511PEX	P	8-pin, Dual InLine Plastic (DIP)

Notes:

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- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- E = Pb-free and Green
- X suffix = Tape/Reel

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